

MA2B001

Silicon planar type trigger device

Thyristor TRIAC trigger circuit

■ Features

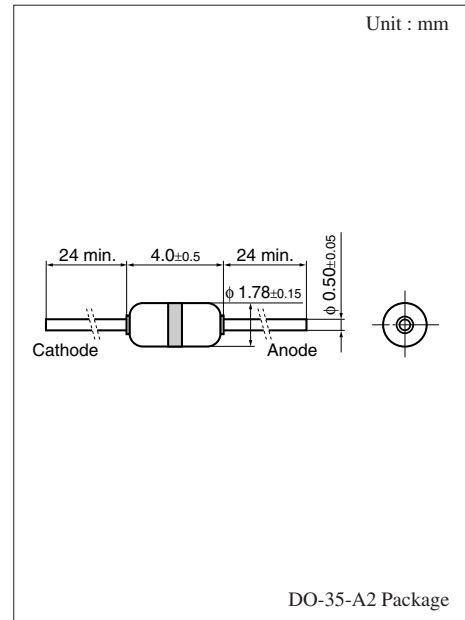
- Satisfactory symmetry of breakover voltage V_{BO}
- Large output voltage V_O and small breakover current I_{BO}

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Rating | Unit |
|----------------------------------|-------------|-------------|------------------|
| Power dissipation (Average) | $P_{D(AV)}$ | 150 | mW |
| Peak current *1 | I_P | 2.0 | A |
| Operating ambient temperature *2 | T_{opr} | 100 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +125 | $^\circ\text{C}$ |

Note) *1: $T_a < 50^\circ\text{C}$, $t = 10 \mu\text{s}$, repetitive frequency 60 Hz

*2: Maximum ambient temperature during operation



■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

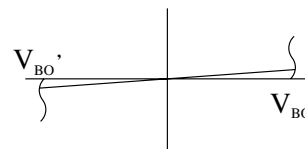
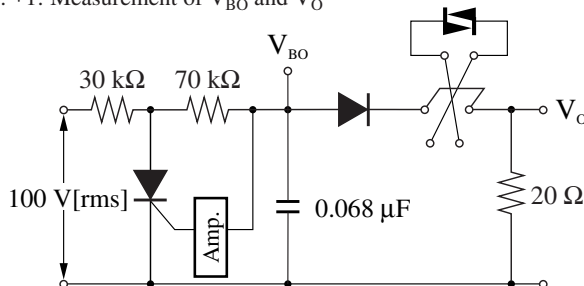
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|--|------------------|--------------|-----|-----|-----|---------------------|
| Breakover voltage *1 | V_{BO} | $I = I_{BO}$ | 28 | | 36 | V |
| Output voltage *1 | V_O | | 4.0 | 7.0 | | V |
| Breakover current | I_{BO} | $V = V_{BO}$ | | | 50 | μA |
| Temperature coefficient of breakover voltage | T.C.(V_{BO}) | | | 0.1 | | $\%/^\circ\text{C}$ |
| Breakover voltage deviation *2 | ΔV_{BO} | | | | 3.5 | V |

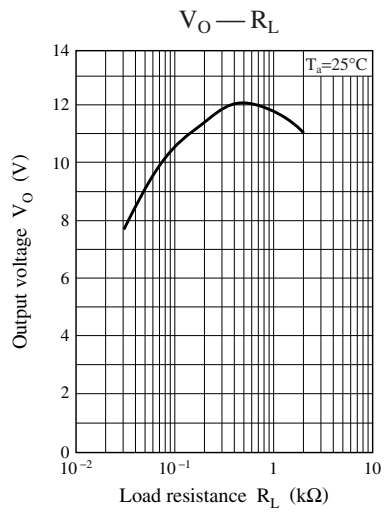
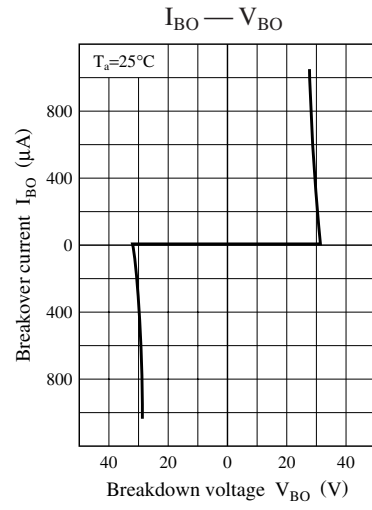
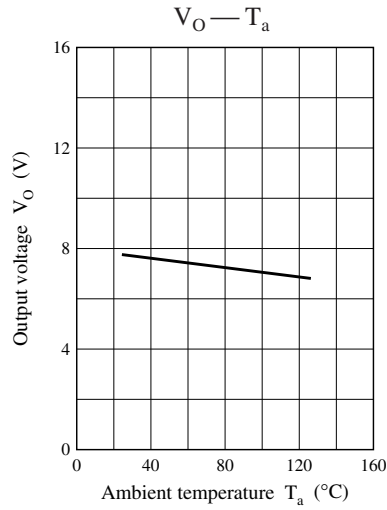
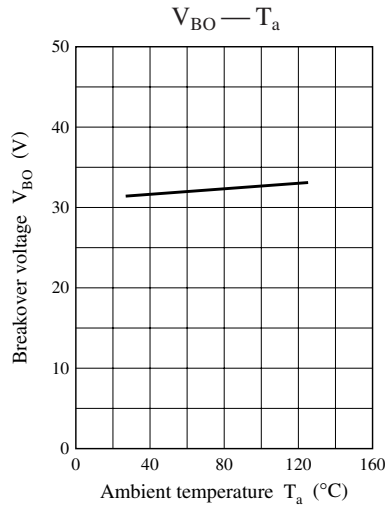
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 100 MHz.

3. *1: Measurement of V_{BO} and V_O

*2: Symmetry of V_{BO}





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